

Description

The AP2204 series is a positive voltage regulator IC fabricated by high voltage EPNP process.

The AP2204 has features of wide input voltage range, high accuracy, high ripple rejection, low dropout voltage, low noise, current limit and ultra-low quiescent current which make it ideal for use in various USB and portable devices.

The IC consists of a voltage reference, an error amplifier, a resistor network for setting output voltage, a current limit circuit for current protection, and a chip enable circuit.

The AP2204 has 1.5V, 1.8V, 2.5V, 2.8V, 3.0V, 3.3V, 5.0V fixed voltage versions and adjustable voltage version.

The AP2204 is available in space-saving SOT-23-5, SOT-89 and PSOP-8 packages.

Features

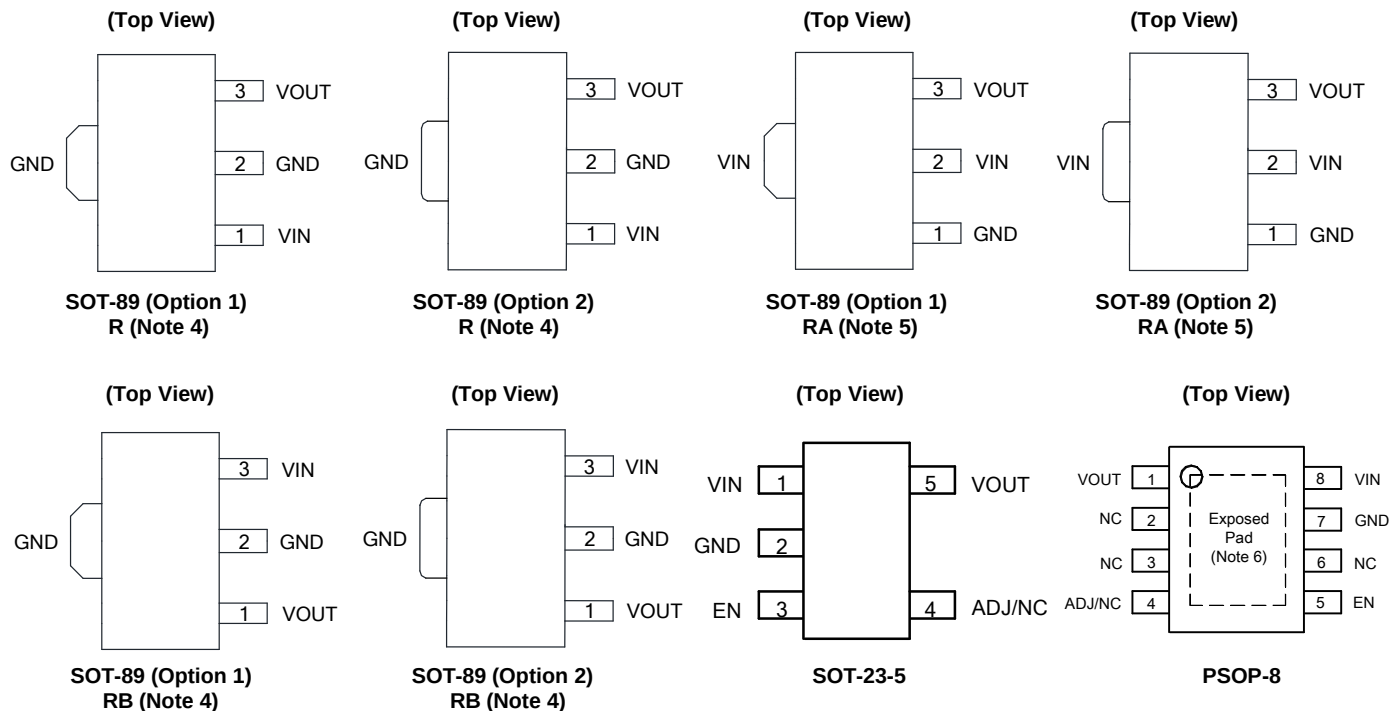
- Wide Input Voltage Range: 2.3V to 24V
- Wide Output Voltage Range: 1.24V to 22V
- Excellent Ripple Rejection: 60dB@ f = 1kHz
- Low Dropout Voltage: $V_{DROP} = 100mV@ I_{OUT} = 100\mu A$
- Low Ground Current
- High Output Voltage Accuracy
- Compatible with Low ESR Ceramic Capacitor
- Excellent Line/Load Regulation
- Thermal Shutdown Function
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Applications

- Battery-powered Equipment
- Laptop, Palmtops, Notebook Computers
- Portable Information Appliances

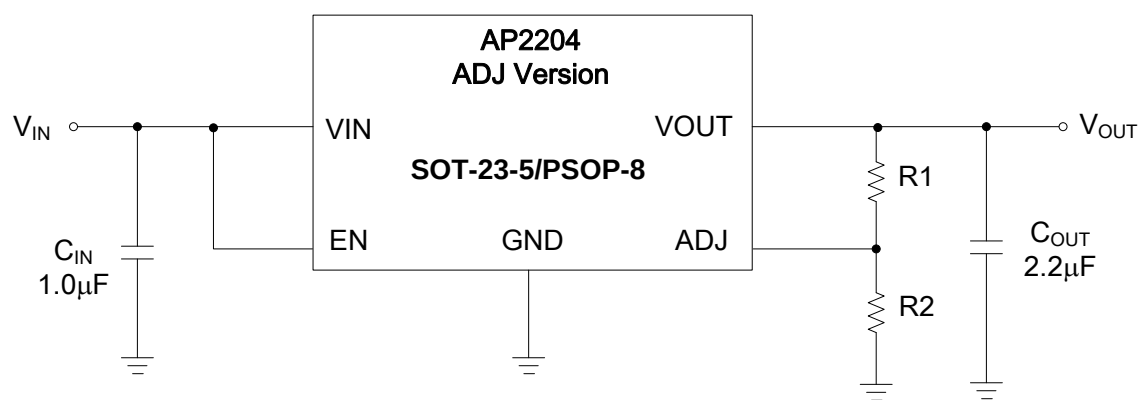
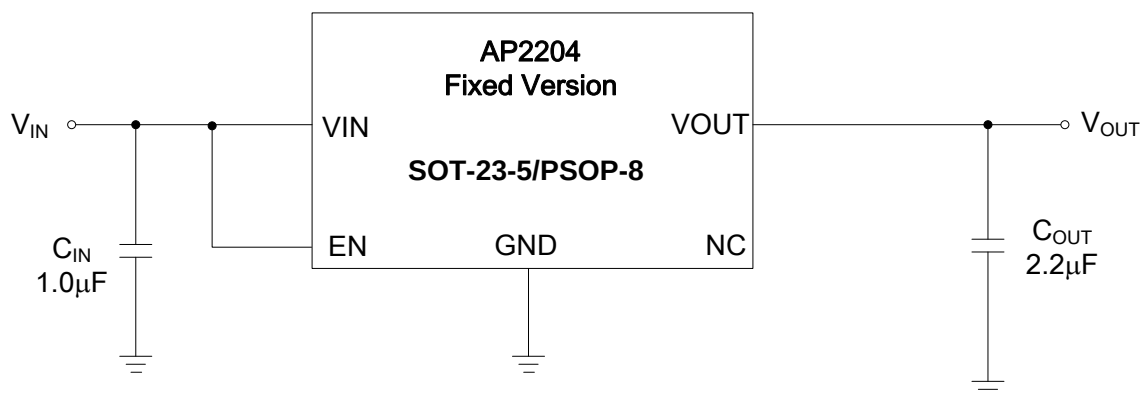
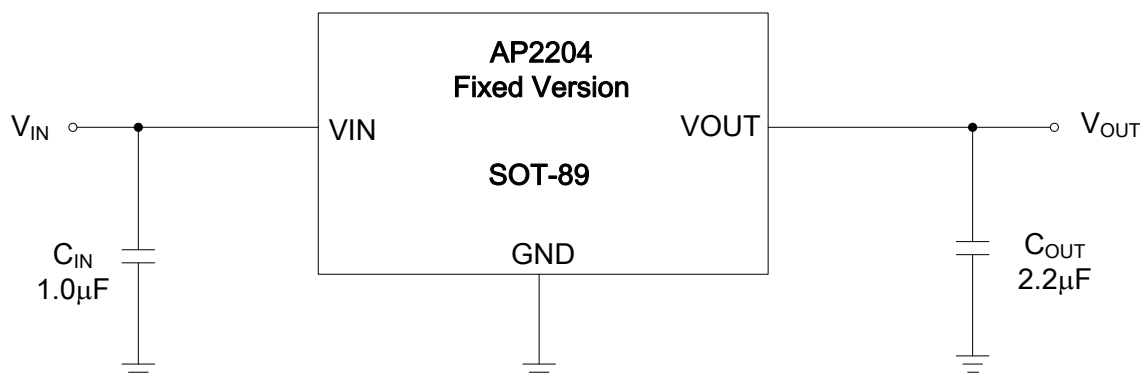
- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Pin Assignments



- Notes:
4. The substrate/exposed pad should be connected to GND or open.
 5. The substrate/exposed pad should be connected to VIN or open.
 6. The exposed pad should be connected to GND for better dissipation.

Typical Applications Circuit

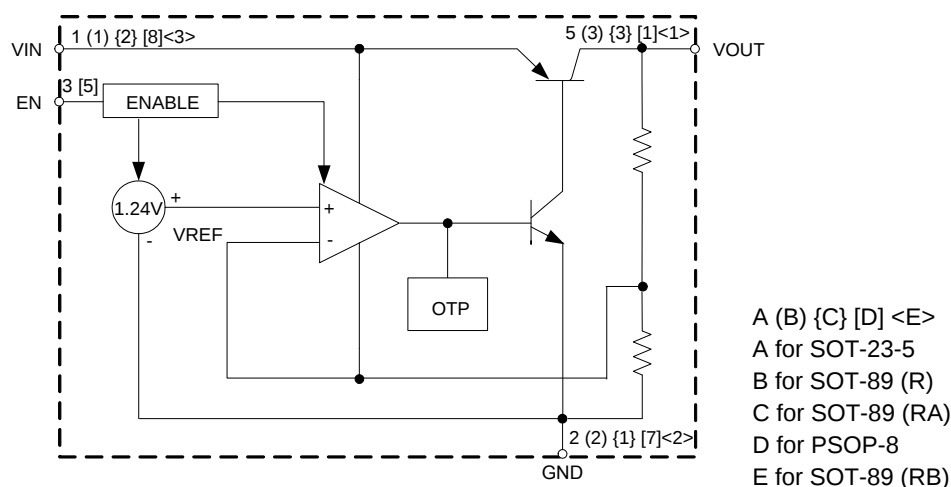


$$V_{OUT} = V_{REF}(1 + (R1/R2))$$

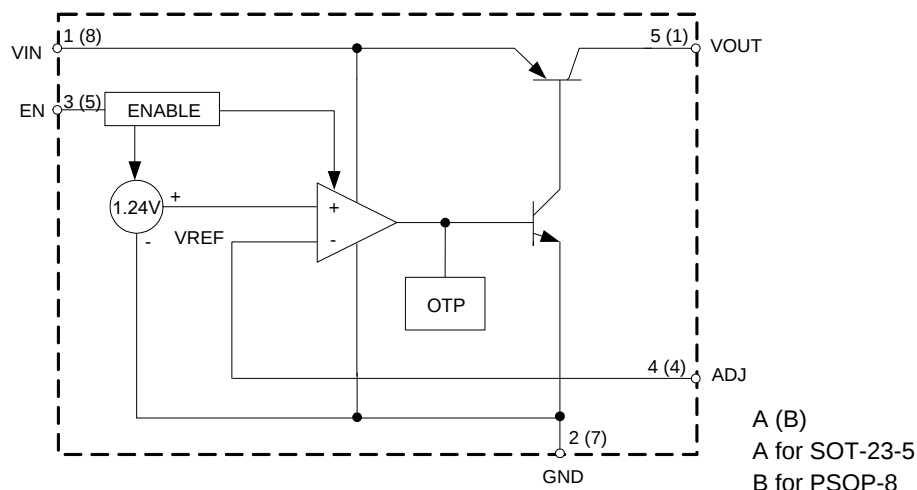
Pin Descriptions

Pin Number					Pin Name	Function
SOT-23-5	PSOP-8	SOT-89				
		R	RA	RB		
1	8	1	2	3	VIN	Input voltage
2	7	2	1	2	GND	Ground
3	5	–	–	–	EN	Enable input
4	4	–	–	–	ADJ/NC	Adjust output for ADJ version/No connected for fixed version
5	1	3	3	1	VOUT	Regulated output voltage

Functional Block Diagram



Fixed Output Voltage



Adjustable Output Voltage

Absolute Maximum Ratings (Note 7)

Symbol	Parameter	Rating		Unit
V_{IN}	Supply Input Voltage	38		V
V_{CE}	Enable Input Voltage	38		V
I_{OUT}	Output Current	250		mA
T_{LEAD}	Lead Temperature (Soldering, 10sec)	+260		°C
T_J	Operating Junction Temperature	+150		°C
θ_{JA}	Thermal Resistance	SOT-23-5	250	°C/W
		SOT-89	165	
		PSOP-8 (Note 8)	51	
T_{STG}	Storage Temperature Range	-65 to +150		°C
—	ESD (Machine Model)	275		V
—	ESD (Human Body Model)	2000		V

Notes: 7. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

8. θ_{JA} is measured with the component mounted on a 2-Layer FR-4 PCB board with 1.5cm*1.5cm thermal sink pad in free air.

Recommended Operating Conditions

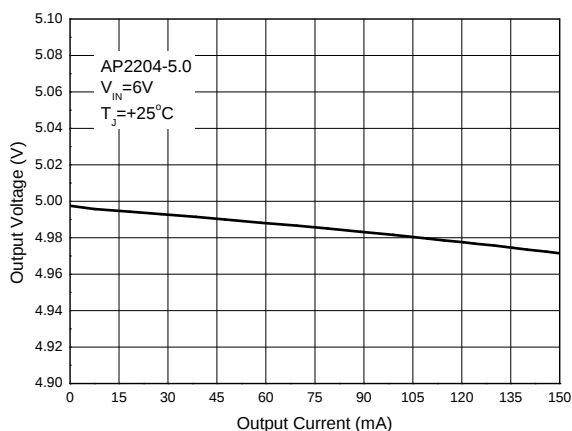
Symbol	Parameter	Min	Max	Unit
V_{IN}	Supply Input Voltage	2.3	24	V
T_J	Operating Junction Temperature	-40	+125	°C

Electrical Characteristics (@ $V_{IN} = V_{OUT} + 1V$, $T_J = +25^{\circ}C$, $I_{OUT} = 100\mu A$, $C_{IN} = 1.0\mu F$, $C_{OUT} = 2.2\mu F$, **Bold** typeface applies over $-40^{\circ}C \leq T_J \leq +125^{\circ}C$, unless otherwise specified.)

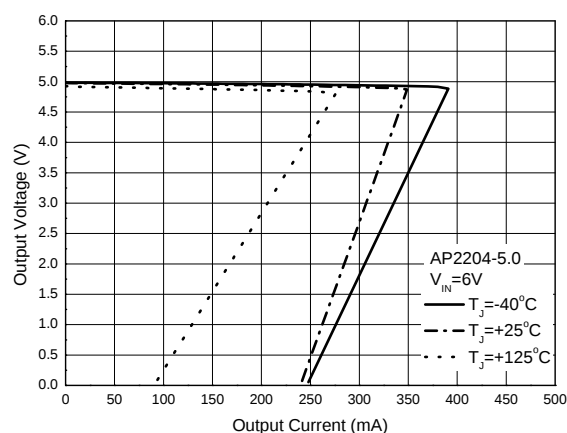
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OUT}	Output Voltage	Variation from Specified V_{OUT}	$V_{OUT} \times 98\%$	–	$V_{OUT} \times 102\%$	V
V_{REF}	Reference Voltage	–	1.215	1.24	1.265	V
V_{IN}	Input Voltage	–	–	–	24	V
$I_{OUT(max)}$	Maximum Output Current	$V_{IN} - V_{OUT} = 1V$, $V_{OUT} = 98\% \times V_{OUT}$	150	200	–	mA
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$V_{OUT} + 1V \leq V_{IN} \leq 24V$	–	0.05	–	%
$\Delta V_{OUT}/I_{OUT}$	Load Regulation	$1mA \leq I_{OUT} \leq 150mA$	–	0.5	–	%
V_{DROP}	Dropout Voltage	$I_{OUT} = 100\mu A$	–	100	150	mV
		$I_{OUT} = 50mA$	–	270	350	
		$I_{OUT} = 100mA$	–	320	460	
		$I_{OUT} = 150mA$	–	360	500	
I_{GND}	Ground Current	$I_{OUT} = 0A$	–	20	–	μA
		$I_{OUT} = 100\mu A$	–	50	–	
		$I_{OUT} = 50mA$	–	0.5	–	mA
		$I_{OUT} = 100mA$	–	1.3	–	
		$I_{OUT} = 150mA$	–	2.5	–	
I_{STD}	Standby Current	$V_{IN} = V_{OUT} + 1V$ V_{EN} in OFF Mode	–	0.01	1.0	μA
PSRR	Power Supply Rejection Ration	Ripple 0.5V _{P-P} $V_{IN} = V_{OUT} + 1V$	$f = 100Hz$	–	60	dB
			$f = 1kHz$	–	60	
$\Delta V_{OUT}/(V_{OUT} \times \Delta T)$	Output Voltage Temperature Coefficient	$I_{OUT} = 100\mu A$, $-40^{\circ}C \leq T_J \leq +125^{\circ}C$	–	± 100	–	ppm/ $^{\circ}C$
V_{NOI}	RMS Output Noise	$T_J = +25^{\circ}C$, $10Hz \leq f \leq 100kHz$	–	30	–	μV_{rms}
I_{ADJ}	ADJ Pin Current	$I_{OUT} = 100\mu A$	–	0.5	–	μA
I_{EN}	EN Pin Current	$V_{EN} = V_{OUT} + 1V$	–	1	–	μA
–	EN “High” Voltage	EN Input Voltage “High”	2.0	–	–	V
–	EN “Low” Voltage	EN Input Voltage “Low”	–	–	0.4	V
θ_{JC}	Thermal Resistance (Junction to Case)	SOT-23-5	–	43	–	$^{\circ}C/W$
		SOT-89	–	27	–	
		PSOP-8	–	22	–	

Performance Characteristics

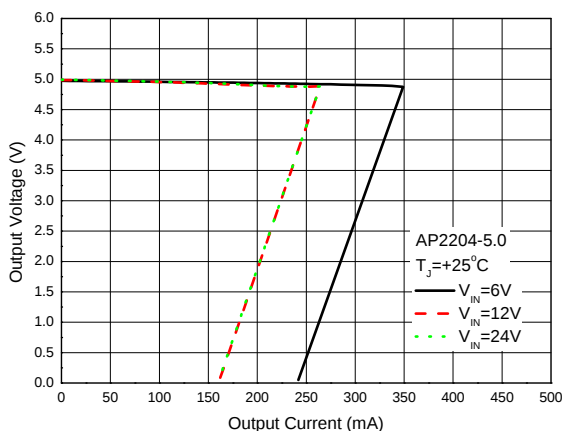
Output Voltage vs. Output Current



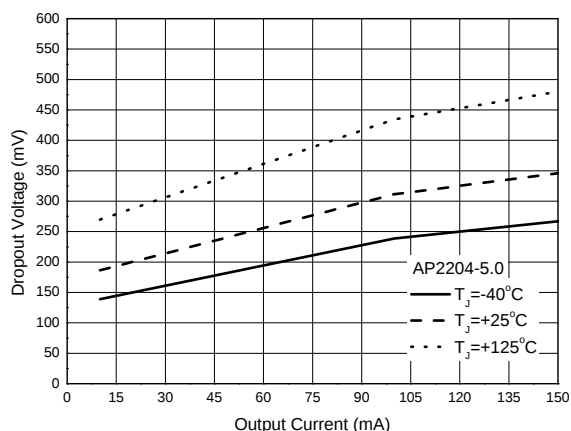
Output Voltage vs. Output Current



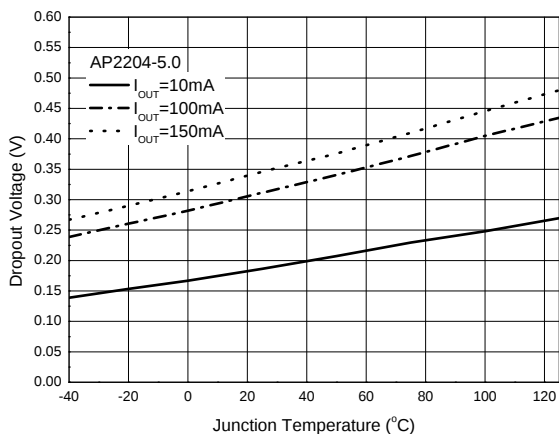
Output Voltage vs. Output Current



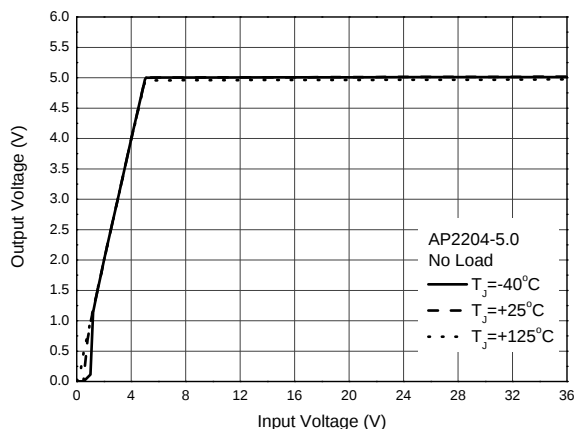
Dropout Voltage vs. Output Current



Dropout Voltage vs. Junction Temperature

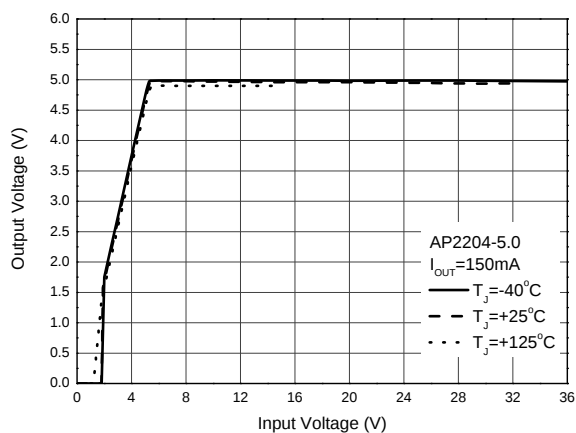


Output Voltage vs. Input Voltage

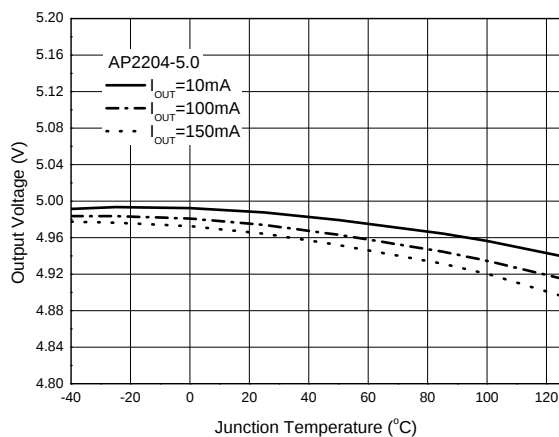


Performance Characteristics (Cont.)

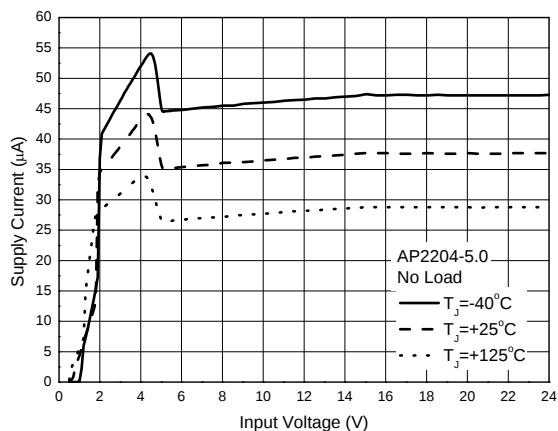
Output Voltage vs. Input Voltage



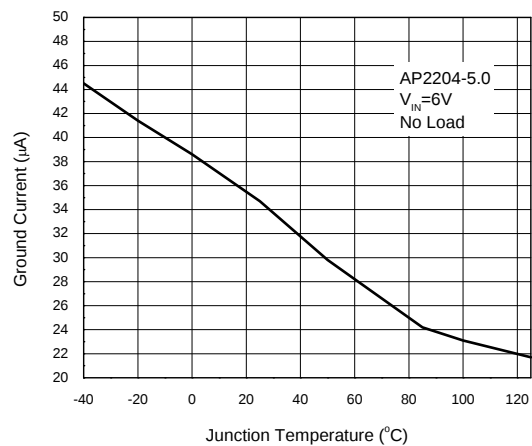
Output Voltage vs. Junction Temperature



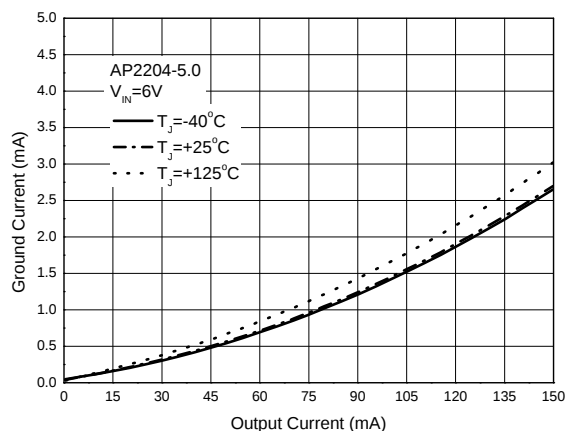
Supply Current vs. Input Voltage



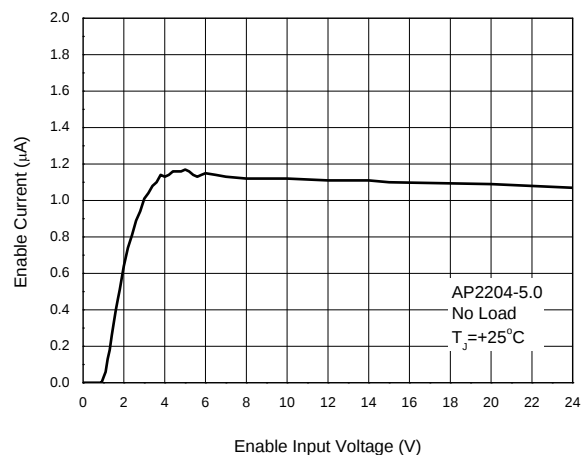
Ground Current vs. Junction Temperature



Ground Current vs. Output Current



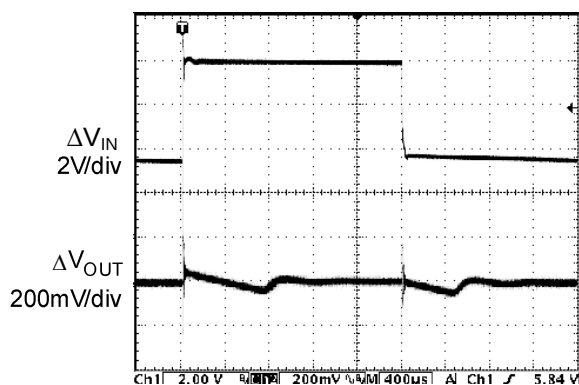
Enable Current vs. Enable Input Voltage



Performance Characteristics (Cont.)

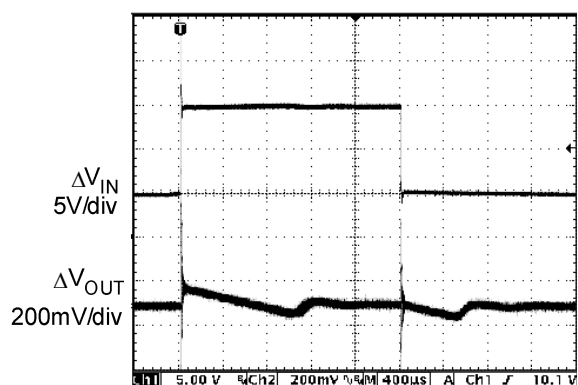
Line Transient

(Conditions: $V_{IN} = V_{EN} = 3.5V$ to $8V$, $C_{IN} = 1.0\mu F$, $C_{OUT} = 2.2\mu F$, $I_{OUT} = 1mA$)



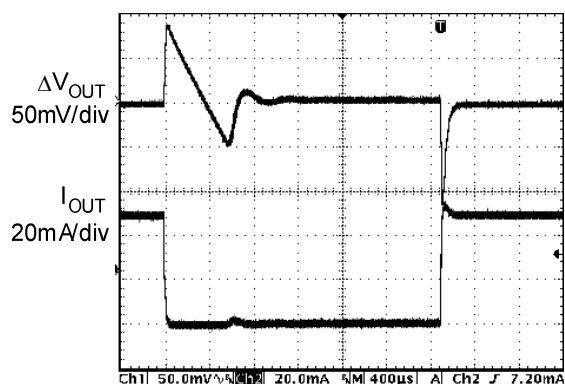
Line Transient

(Conditions: $V_{IN} = V_{EN} = 5V$ to $15V$, $C_{IN} = 1.0\mu F$, $C_{OUT} = 2.2\mu F$, $I_{OUT} = 1mA$)



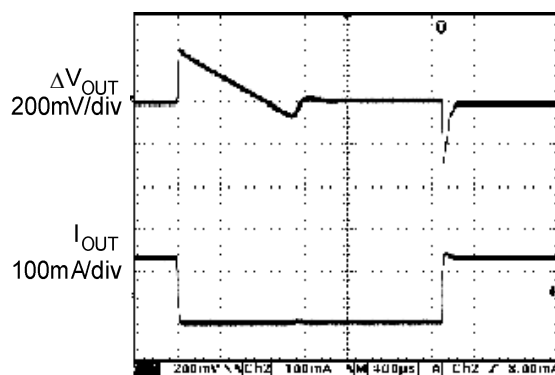
Load Transient

(Conditions: $V_{IN} = 5V$, $C_{IN} = 1.0\mu F$, $C_{OUT} = 2.2\mu F$, $I_{OUT} = 1mA$ to $50mA$)

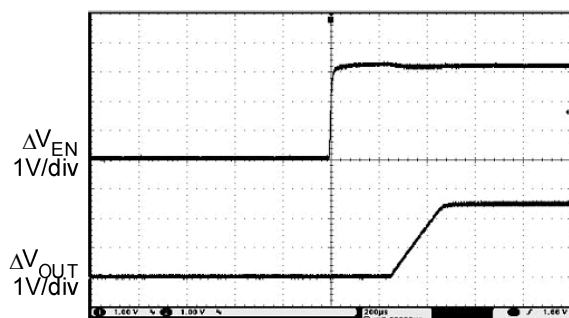


Load Transient

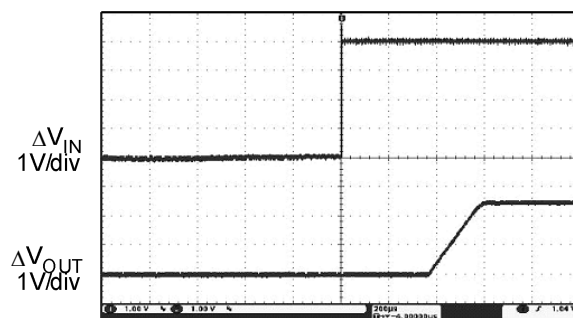
(Conditions: $V_{IN} = 5V$, $C_{IN} = 1.0\mu F$, $C_{OUT} = 2.2\mu F$, $I_{OUT} = 1mA$ to $150mA$)



Enable Input Response

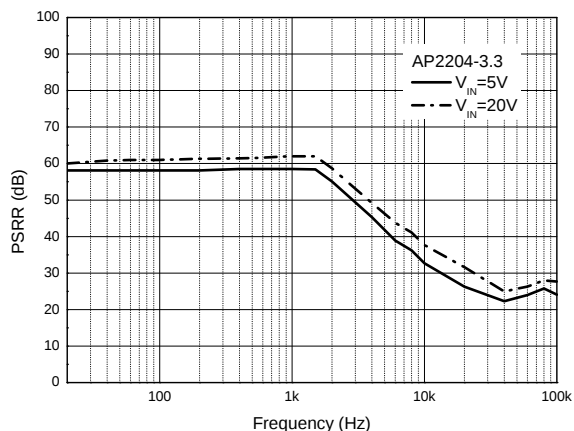


Start-up Response

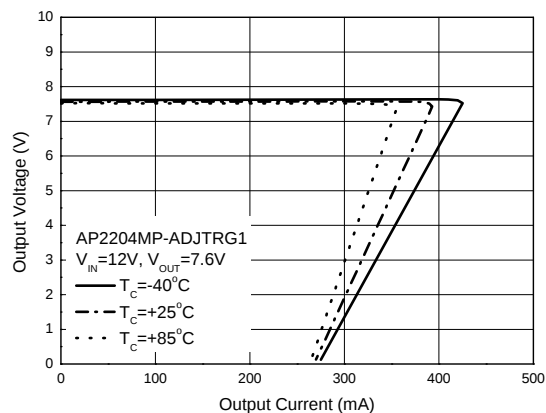


Performance Characteristics (Cont.)

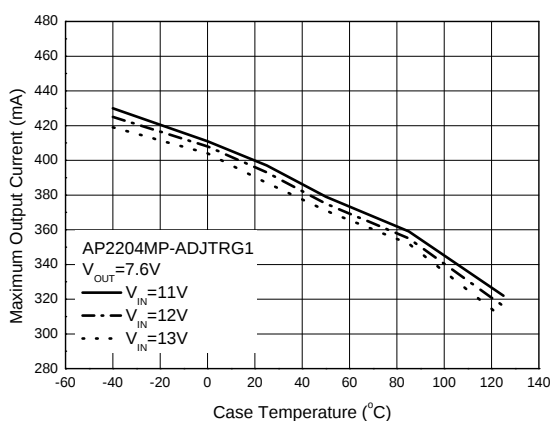
PSRR vs. Frequency
(Conditions: $V_{PP}=2V$, $I_{OUT}=10mA$)



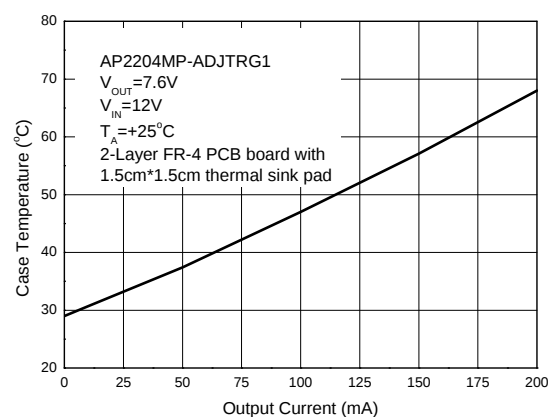
Output Voltage vs. Output Current



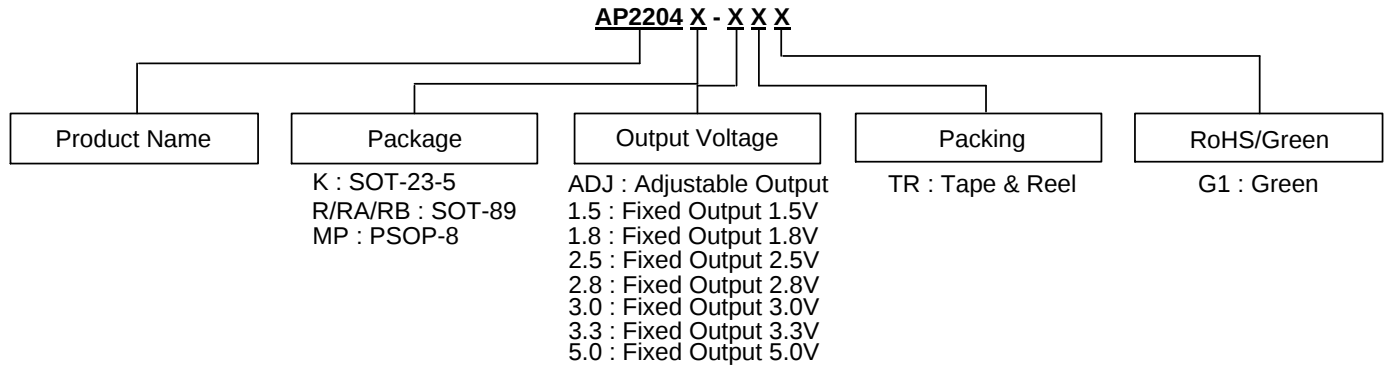
Maximum Output Current vs. Case Temperature



Case Temperature vs. Output Current



Ordering Information

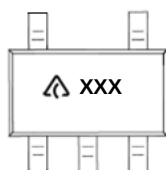


Package	Temperature Range	Output Voltage	Part Number	Marking ID	Packing
SOT-23-5	-40 to +85°C	ADJ	AP2204K-ADJTRG1	GAF	3000/7" Tape & Reel
		1.5V	AP2204K-1.5TRG1	GBH	3000/7" Tape & Reel
		1.8V	AP2204K-1.8TRG1	GAG	3000/7" Tape & Reel
		2.5V	AP2204K-2.5TRG1	GAD	3000/7" Tape & Reel
		2.8V	AP2204K-2.8TRG1	GAE	3000/7" Tape & Reel
		3.0V	AP2204K-3.0TRG1	GEF	3000/7" Tape & Reel
		3.3V	AP2204K-3.3TRG1	GAH	3000/7" Tape & Reel
		5.0V	AP2204K-5.0TRG1	GAI	3000/7" Tape & Reel
SOT-89	-40 to +85°C	1.5V (R)	AP2204R-1.5TRG1	G22C	1000/7" Tape & Reel
		1.8V (R)	AP2204R-1.8TRG1	G31C	1000/7" Tape & Reel
		2.5V (R)	AP2204R-2.5TRG1	G22D	1000/7" Tape & Reel
		2.8V (R)	AP2204R-2.8TRG1	G22E	1000/7" Tape & Reel
		3.0V (R)	AP2204R-3.0TRG1	G22F	1000/7" Tape & Reel
		3.3V (R)	AP2204R-3.3TRG1	G31D	1000/7" Tape & Reel
		5.0V (R)	AP2204R-5.0TRG1	G31E	1000/7" Tape & Reel
SOT-89	-40 to +85°C	3.3V (RA)	AP2204RA-3.3TRG1	G37O	1000/7" Tape & Reel
		5.0V (RA)	AP2204RA-5.0TRG1	G41O	1000/7" Tape & Reel
SOT-89	-40 to +85°C	3.3V (RB)	AP2204RB-3.3TRG1	G37R	1000/7" Tape & Reel
		5.0V (RB)	AP2204RB-5.0TRG1	G41R	1000/7" Tape & Reel
PSOP-8	-40 to +85°C	ADJ	AP2204MP-ADJTRG1	2204MP-ADJG1	4000/13" Tape & Reel

Marking Information

(1) SOT-23-5

(Top View)

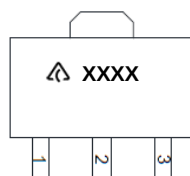


 : Logo

XXX: Marking ID (See Ordering Information)

(2) SOT-89

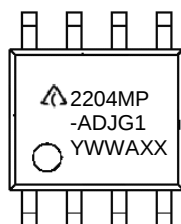
(Top View)



First Line: Logo and Marking ID
(See Ordering Information)

(3) PSOP-8

(Top View)



First and Second Lines: Logo and Marking ID
(See Ordering Information)

Third Line: Date Code

Y: Year

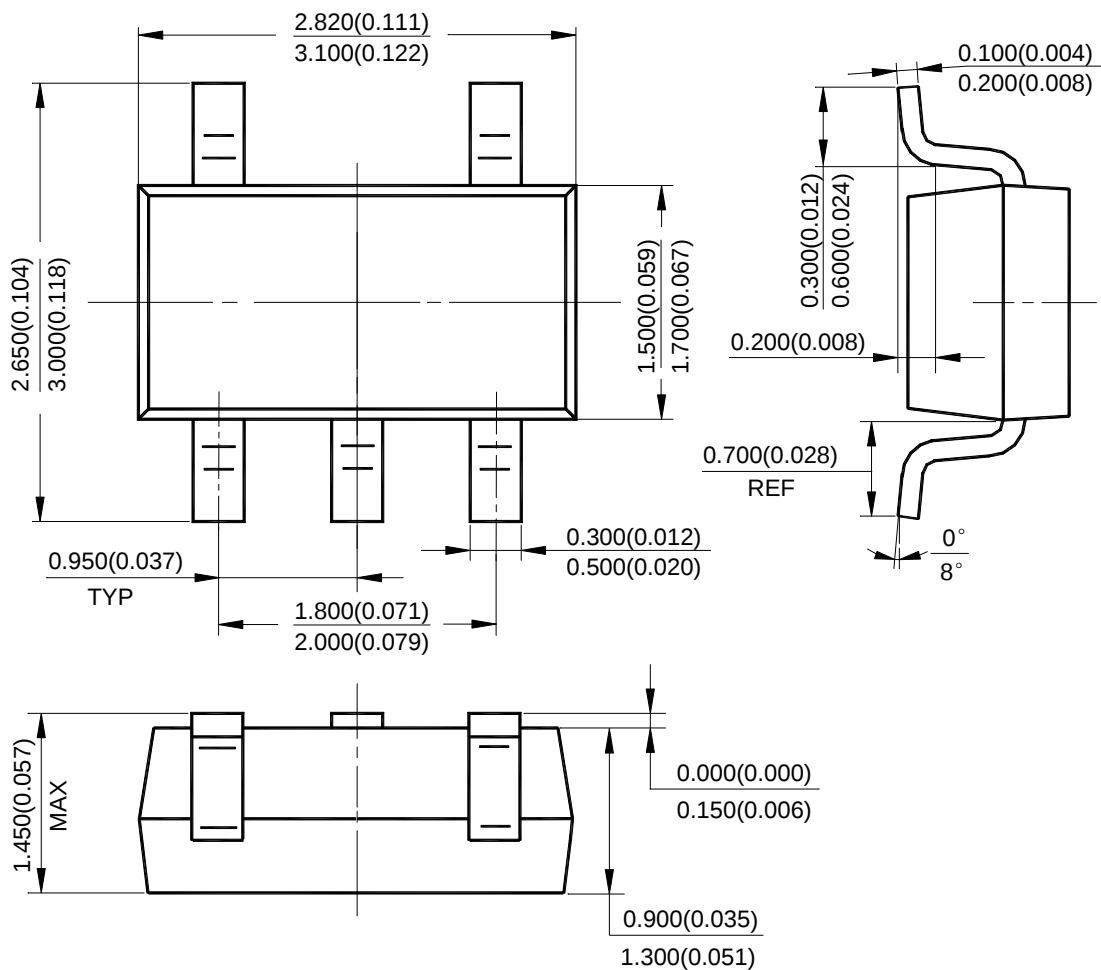
WW: Work Week of Molding

A: Assembly House Code

XX: 7th and 8th Digits of Batch Number

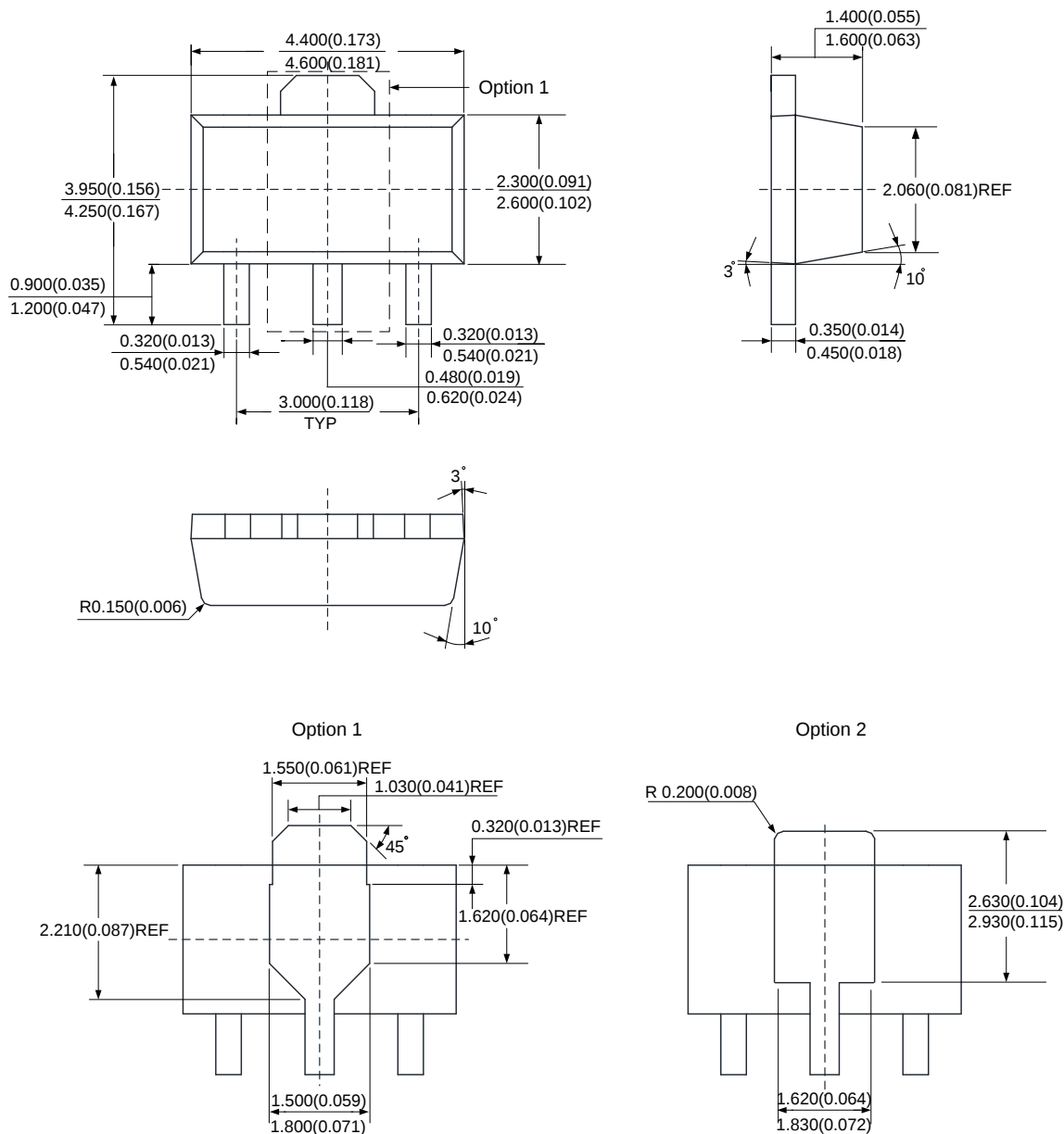
Package Outline Dimensions (All dimensions in mm(inch).)

(1) Package Type: SOT-23-5



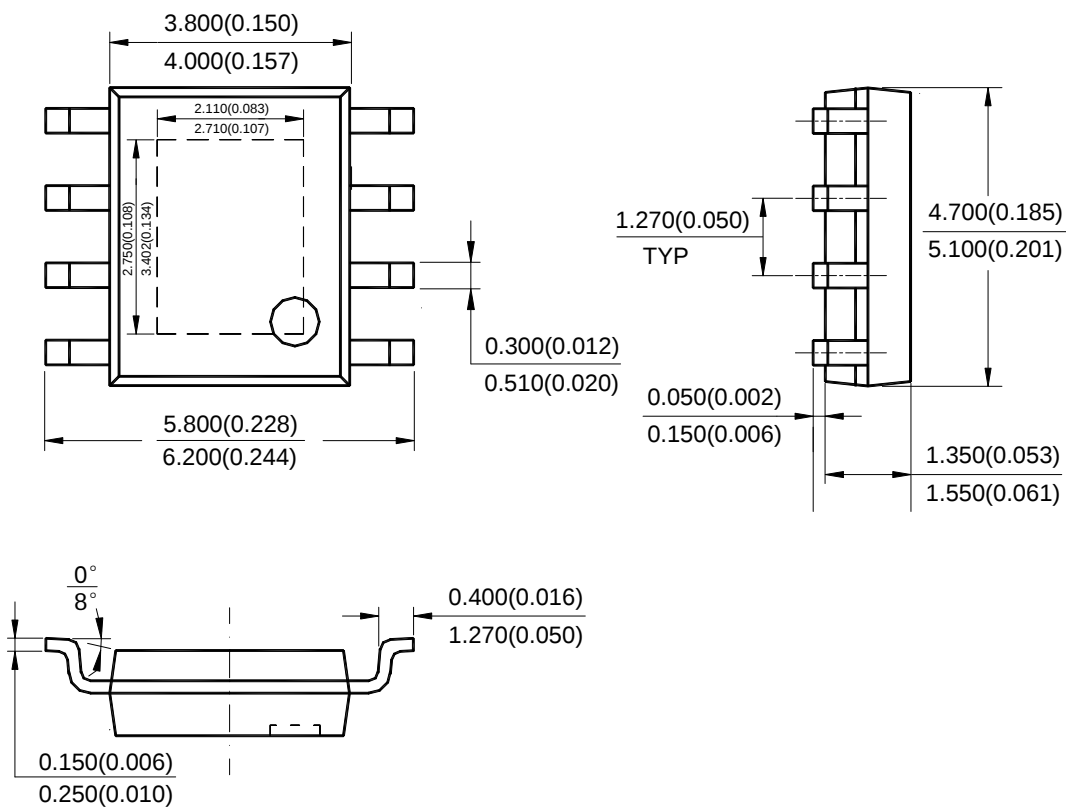
Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(2) Package Type: SOT-89



Package Outline Dimensions (Cont. All dimensions in mm(inch).)

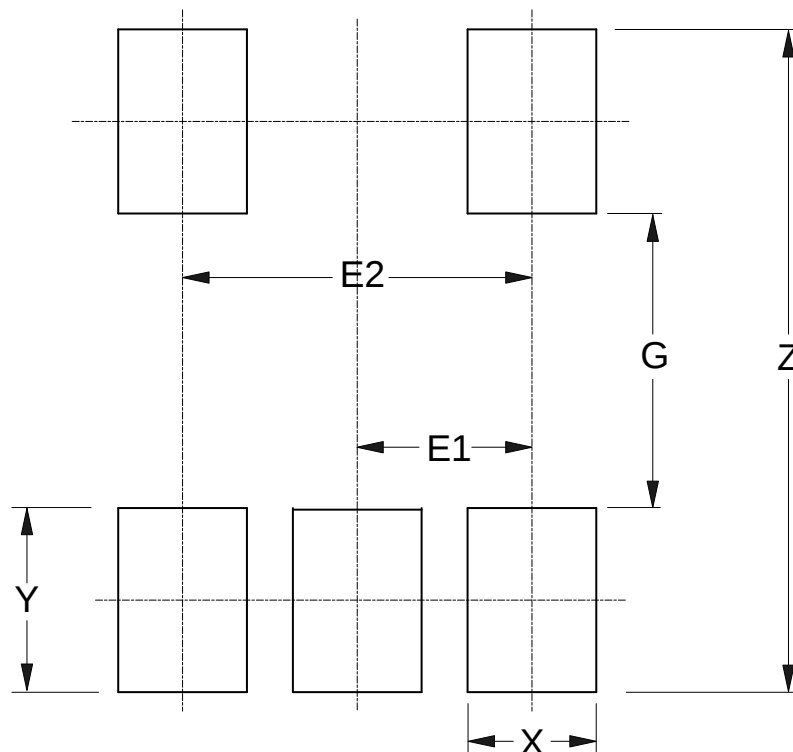
(3) Package Type: PSOP-8



Note: Eject hole, oriented hole and mold mark is optional.

Suggested Pad Layout

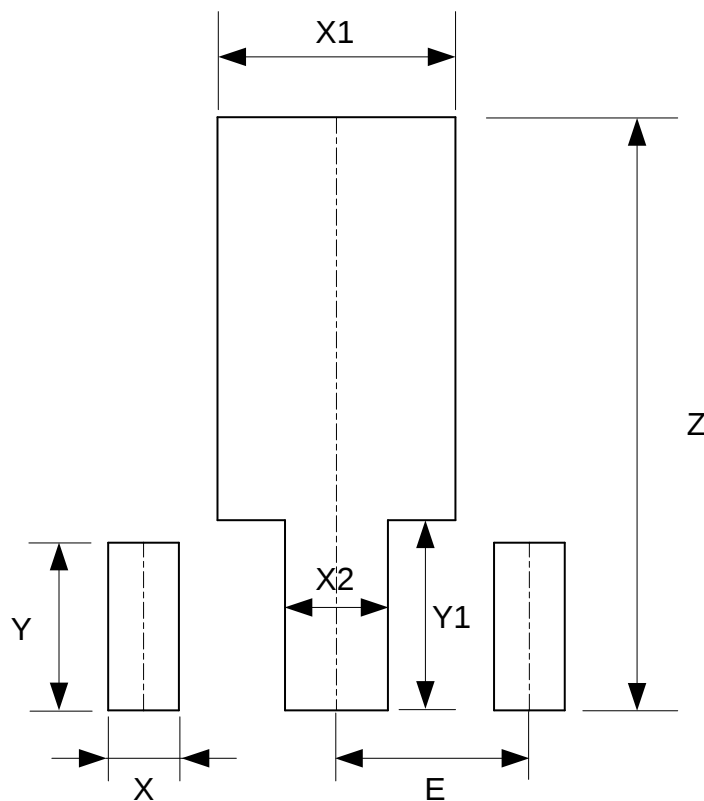
(1) Package Type: SOT-23-5



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E1 (mm)/(inch)	E2 (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037	1.900/0.075

Suggested Pad Layout (Cont.)

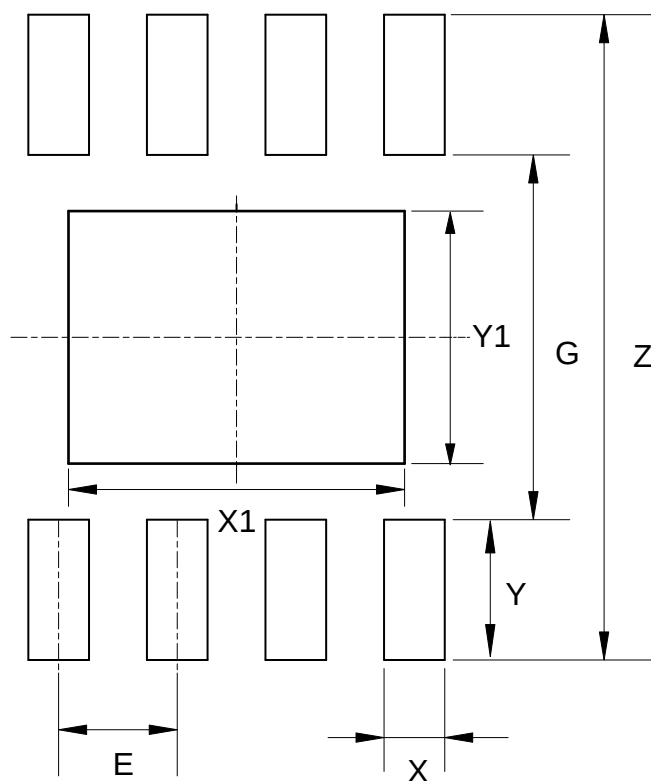
(2) Package Type: SOT-89



Dimensions	Z (mm)/(inch)	X (mm)/(inch)	X1 (mm)/(inch)	X2 (mm)/(inch)	Y (mm)/(inch)	Y1 (mm)/(inch)	E (mm)/(inch)
Value	4.600/0.181	0.550/0.022	1.850/0.073	0.800/0.031	1.300/0.051	1.475/0.058	1.500/0.059

Suggested Pad Layout (Cont.)

(3) Package Type: PSOP-8



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	X1 (mm)/(inch)	Y1 (mm)/(inch)	E (mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	3.600/0.142	2.700/0.106	1.270/0.050

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